High Voltage Transistor

PNP Silicon

MMBT6520L, **NSVMMBT6520L**

Features

- NSV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

MAXIMUM RATINGS

Symbol	Rating	Value	Unit
V _{CEO}	Collector - Emitter Voltage	-350	Vdc
V _{CBO}	Collector - Base Voltage	-350	Vdc
V _{EBO}	Emitter – Base Voltage	-5.0	Vdc
Ι _Β	Base Current	-250	mA
I _C	Collector Current - Continuous	-500	mAdc

THERMAL CHARACTERISTICS

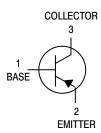
Symbol	Characteristic	Max	Unit
P _D	Total Device Dissipation FR-5 Board, (Note 1) T _A = 25°C Derate above 25°C	225 1.8	mW mW/°C
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	556	°C/W
P _D	Total Device Dissipation Alumina Substrate, (Note 2) T _A = 25°C Derate above 25°C	300 2.4	mW mW/°C
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	417	°C/W
T _J , T _{stg}	Junction and Storage Temperature	-55 to +150	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

- 1. $FR-5 = 1.0 \times 0.75 \times 0.062$ in.
- 2. Alumina = 0.4 x 0.3 x 0.024 in. 99.5% alumina.



SOT-23 (TO-236) **CASE 318** STYLE 6



MARKING DIAGRAM



2Z = Device Code M = Date Code*

= Pb-Free Package

(Note: Microdot may be in either location)

*Date Code orientation and/or overbar may vary depending upon manufacturing location.

ORDERING INFORMATION

Device	Package	Shipping [†]
MMBT6520LT1G	SOT-23 (Pb-Free)	3,000 / Tape & Reel
NSVMMBT6520LT1G	SOT-23 (Pb-Free)	3,000 / Tape & Reel

DISCONTINUED (Note 1)

MMBT6520LT3G	SOT-23	10,000 / Tape &
	(Pb-Free)	Reel

- †For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.
- 1. DISCONTINUED: These devices are not recommended for new design. Please contact your onsemi representative for information. The most current information on these devices may be available on www.onsemi.com.

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MMBT6520L, NSVMMBT6520L

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

Symbol	Characteristic	Min	Max	Unit		
OFF CHARA	OFF CHARACTERISTICS					
V _{(BR)CEO}	Collector-Emitter Breakdown Voltage (I _C = -1.0 mA)	-350	_,	Vdc		
V _{(BR)CBO}	Collector-Base Breakdown Voltage (I _C = -100 μA)	-350	-	Vdc		
V _{(BR)EBO}	Emitter-Base Breakdown Voltage $(I_E = -10 \mu A)$	-5.0	-	Vdc		
I _{CBO}	Collector Cutoff Current (V _{CB} = -250 V)	-	-50	nA		
I _{EBO}	Emitter Cutoff Current (V _{EB} = -4.0 V)	-	-50	nA		
ON CHARAC	TERISTICS					
h _{FE}	DC Current Gain	20 30 30 20 15	- 200 200 -	-		
V _{CE(sat)}	Collector–Emitter Saturation Voltage	- - - -	-0.30 -0.35 -0.50 -1.0	Vdc		
V _{BE(sat)}	Base–Emitter Saturation Voltage $ \begin{array}{l} (I_C=-10 \text{ mA},\ I_B=-1.0 \text{ mA})\\ (I_C=-20 \text{ mA},\ I_B=-2.0 \text{ mA})\\ (I_C=-30 \text{ mA},\ I_B=-3.0 \text{ mA}) \end{array} $	- - -	-0.75 -0.85 -0.90	Vdc		
V _{BE(on)}	Base-Emitter On Voltage (I _C = -100 mA, V _{CE} = -10 V)	-	-2.0	Vdc		
SMALL-SIGI	NAL CHARACTERISTICS					
f _T	Current-Gain - Bandwidth Product (I _C = -10 mA, V _{CE} = -20 V, f = 20 MHz)	40	200	MHz		
C _{cb}	Collector-Base Capacitance (V _{CB} = -20 V, f = 1.0 MHz)	-	6.0	pF		
C _{eb}	Emitter-Base Capacitance (V _{EB} = -0.5 V, f = 1.0 MHz)	-	100	pF		

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

MMBT6520L, NSVMMBT6520L

TYPICAL CHARACTERISTICS

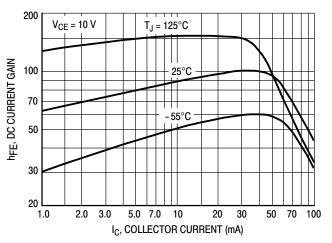


Figure 1. DC Current Gain

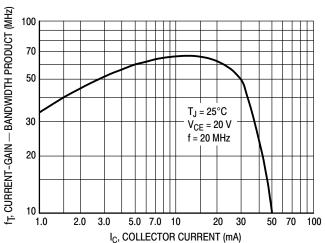


Figure 2. Current-Gain — Bandwidth Product

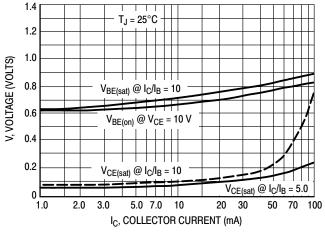


Figure 3. "On" Voltages

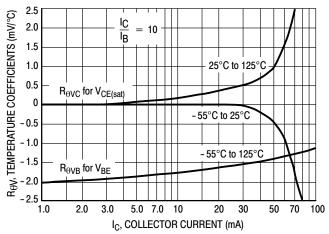


Figure 4. Temperature Coefficients

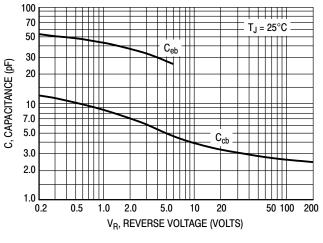


Figure 5. Capacitance

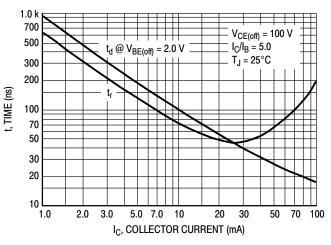


Figure 6. Turn-On Time

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TYPICAL CHARACTERISTICS (continued)

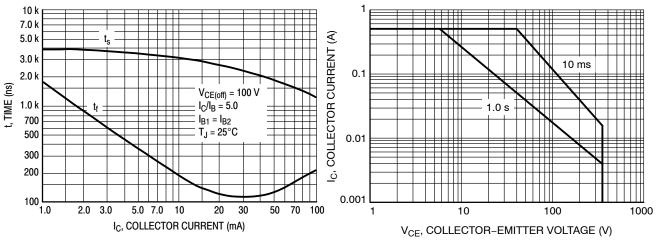


Figure 7. Turn-Off Time

Figure 8. Safe Operating Area

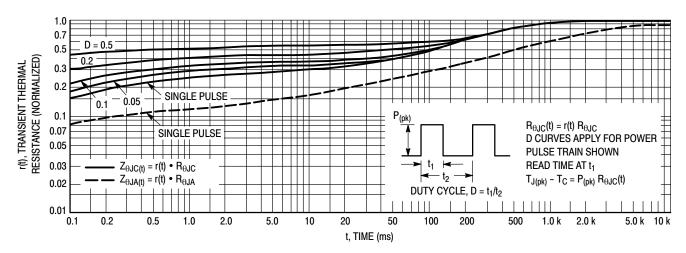


Figure 9. Thermal Response

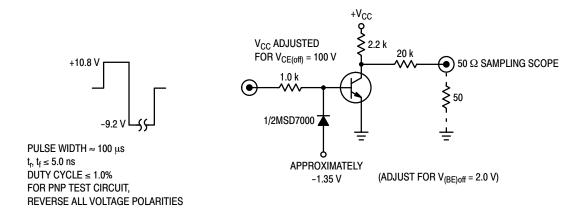


Figure 10. Switching Time Test Circuit

MILLIMETERS

MIN

0.89

0.01

0.37

0.08

2.80

1.20

1.78

0.30

0.35

2.10

O°

NOM

1.00

0.06

0.44

0.14

2.90

1.30

1.90

0.43

0.54

2.40





SOT-23 (TO-236) 2.90x1.30x1.00 1.90P **CASE 318 ISSUE AU**

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MAX

1.11

0.10

0.50

0.20

3.04

1.40

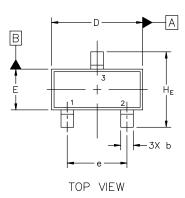
2.04

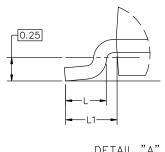
0.55

0.69

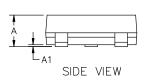
2.64

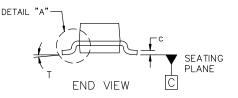
10°

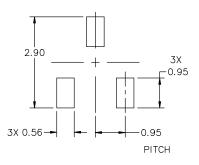




DETAIL "A" Scale 3:1







NOTES:

DIM

Α

Α1

b

С

D

Ε

е L

L1

HE

Τ

- DIMENSIONING AND TOLERANCING 1. PER ASME Y14.5M, 2018. CONTROLLING DIMENSIONS:
- MILLIMETERS.
- MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF THE
- BASE MATERIAL.
 DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS.

GENERIC MARKING DIAGRAM*



XXX = Specific Device Code

= Date Code

= Pb-Free Package

RECOMMENDED MOUNTING FOOTPRINT

* For additional information on our Pb-Free strategy and soldering details, please download the onsemi Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

STYLES ON PAGE 2

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^{*}This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "=", may or may not be present. Some products may not follow the Generic Marking.

SOT-23 (TO-236) 2.90x1.30x1.00 1.90P CASE 318 ISSUE AU

DATE 14 AUG 2024

STYLE 1 THRU 5: CANCELLED	STYLE 6: PIN 1. BASE 2. EMITTER 3. COLLECTOR			
STYLE 9: PIN 1. ANODE 2. ANODE 3. CATHODE	STYLE 10: PIN 1. DRAIN 2. SOURCE 3. GATE	2. CATHODE 2.	2: STYLE 13: CATHODE PIN 1. SOURCE CATHODE 2. DRAIN ANODE 3. GATE	STYLE 14: PIN 1. CATHODE 2. GATE 3. ANODE
STYLE 15: PIN 1. GATE 2. CATHODE 3. ANODE	STYLE 16: PIN 1. ANODE 2. CATHODE 3. CATHODE	2. ANODE 2.	3: STYLE 19: NO CONNECTION PIN 1. CATHODE CATHODE 2. ANODE ANODE 3. CATHODE-ANODE	STYLE 20: PIN 1. CATHODE 2. ANODE 3. GATE
STYLE 21: PIN 1. GATE 2. SOURCE 3. DRAIN	STYLE 22: PIN 1. RETURN 2. OUTPUT 3. INPUT			STYLE 26: PIN 1. CATHODE 2. ANODE 3. NO CONNECTION
STYLE 27: PIN 1. CATHODE 2. CATHODE 3. CATHODE	STYLE 28: PIN 1. ANODE 2. ANODE 3. ANODE			

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